

# MicroLED technologies for quantum systems

Jan Gülink QubeDot GmbH (co-founder & CTO)



Founded 2019

The difference:

We:

 Big Players do no touch their standard processes and often do not think outside their box

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• We understand the InGaN material system

45+ person years of development

Passionate TEAM of ~15 employees

• We are safe to provide any design from 1 ... 1000 µm!

Unique technology to process GaN material system

 Customers receive their <u>customized</u> microLED solution even in small quantities within short lead times





## Monolithic approach: SMILE Platforms

- System with 16 x 16 pixels
- Standardized contact ring for different pixel sizes & pitches & wavelengths.
- 170 kHz frame rate



- System with 8 x 8 pixels
- Standardized contact ring for different pixel sizes & pitches & wavelengths.

![](_page_2_Picture_8.jpeg)

5 μm pixel size 5 μm distance.

Single pixel modulated with 1kHz in this video.

Too fast for camera.

![](_page_2_Picture_12.jpeg)

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From UV to green of course...

## SMILE Platforms – Tuneable native red InGaN

![](_page_3_Picture_1.jpeg)

 Red microLEDs with feature sizes down to 3 µm.

QubeDot

- Tuneable
- Can be adapted to customer designs with several emitters on a chip or distinct microLEDs on wafer
- → Pixel form is sizeindependent

![](_page_3_Picture_6.jpeg)

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![](_page_4_Picture_1.jpeg)

![](_page_4_Picture_2.jpeg)

100µm

#### **Example: Information displays**

![](_page_5_Picture_2.jpeg)

## Assembly of microLED displays

![](_page_6_Figure_2.jpeg)

Copyright: Yole presentation @ Techblick 2021

#### Die size What about the efficiency in the low single-digit micron regime?

Transfer Which transfer mechanism is fast and reaches >> 99,9999% placement yield?

Example 4K Display: 3840 x 2160 (pixels) x 3 (RGB) = 24.88 million microLEDs.
If 99,99% successful transfers.
→ Still 2489 dead pixels...

![](_page_6_Picture_7.jpeg)

### Assembly of quantum computers

Ion-trap based quantum computers need to integrate & combine for example

- Different photonic elements (VCSEL / DFB laser, waveguides,...)
- Electronics (microwave circuits,...)
- Fiber coupling interfaces

On an interposer e.g. with TGVs and high thermal conductivity,...

No single material system can fulfill all requirements.

For scalability & system size reduction:

- Hybrid on-chip integration // Chiplet Design
- Fast & parallel element transfer & connection

Similar to microLED displays or chiplet design in modern CPUs...

# QubeDot

![](_page_7_Picture_12.jpeg)

![](_page_7_Picture_13.jpeg)

![](_page_7_Picture_14.jpeg)

![](_page_7_Picture_15.jpeg)

# **QubeDot** Transfer of photonic elements

Best semiconductor process is nothing without proper transfer tools and reliable interconnection technology.

![](_page_8_Picture_2.jpeg)

#### We perform and offer

- LLO after bonding or
- LIFT for direct µLED transfer+bond

![](_page_8_Figure_6.jpeg)

Laser Induced Forward Transfer (LIFT) is highly parallel and can transfer millions of units per hour.

### **Towards standardization of photonic dies**

Potential size of

- Die 14 // 20 // 40 // 80 // + μm
- Contact pad 5 ... 40 µm any shape
- Emitter
   2 ... 75+ μm

![](_page_9_Figure_5.jpeg)

Dies with size 80 x 80  $\mu$ m<sup>2</sup> with different contact pads. Ready for transfer.

# QubeDot

No "golden way" yet in the industry.

Standards regarding die sizes, contacts, and emitters have huge benefits at the interfaces of all industry players.

![](_page_9_Picture_10.jpeg)

MIRA3 TESCAN

#### **Towards standardization of photonic dies II**

![](_page_10_Figure_2.jpeg)

#### Die size 14 x 14 $\mu$ m<sup>2</sup>.

### Towards standardization of photonic dies III

![](_page_11_Picture_2.jpeg)

![](_page_11_Figure_3.jpeg)

#### Die size $14 \times 14 \mu m^2$ .

![](_page_11_Picture_5.jpeg)

#### **EPIC** questions

What can you do for them?

- Design and processing of LEDs, Lasers, and waveguides
- Application-specific interposer and receivers
- Transfer
- Assembly and Interconnects

What can they do for you?

- Learn about the versatile possibilities of QubeDot and the GaN material system
- Talk to us about needs and potential capability matches I

![](_page_12_Picture_10.jpeg)

#### Your personal contact

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![](_page_13_Picture_4.jpeg)

![](_page_13_Picture_5.jpeg)